

3-line IPAD™, EMI filter including ESD protection

Features

- EMI symmetrical (I/O) low-pass filter
- high efficiency in EMI/ESD protection
- lead-free package
- very thin package
- high reliability offered by monolithic integration
- high reduction of parasitic elements through integration and wafer level packaging

Complies with the following standards

- IEC 61000-4-2 level 4 (on external pins B1 and C1):
 - ±15 kV (air discharge)
 - ±8 kV (contact discharge)
- IEC 61000-4-2 level 1 (on internal pins):
 - ±2 kV (air discharge)
 - ±2 kV (contact discharge)

Applications

Where EMI filtering in ESD sensitive equipment is required:

- mobile phones and communication systems
- computers, printers and MCU boards

Description

The EMIF02-USB04F3 chip is a highly integrated audio filter device designed to suppress EMI/RFI noise in all systems subjected to electromagnetic interference.

This filter includes ESD protection circuitry, which prevents damage to the protected device when subjected to ESD surges up to 15 kV.

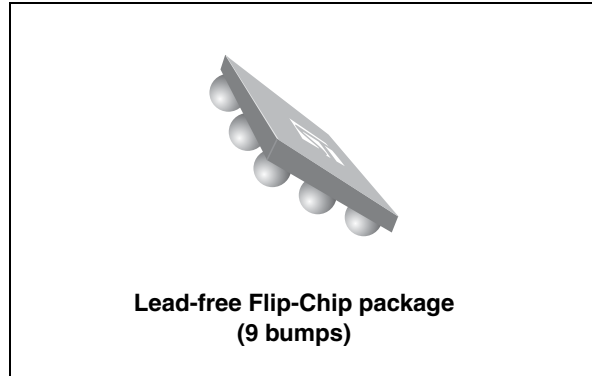


Figure 1. Pin configuration (bump side)

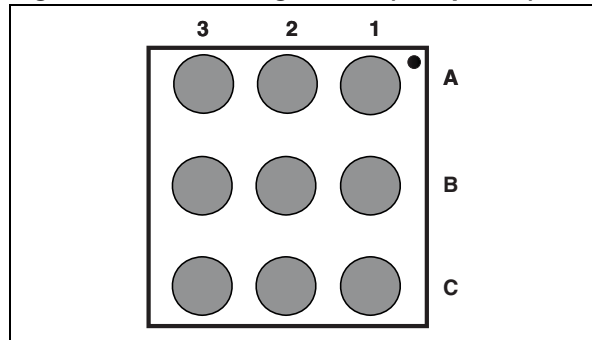
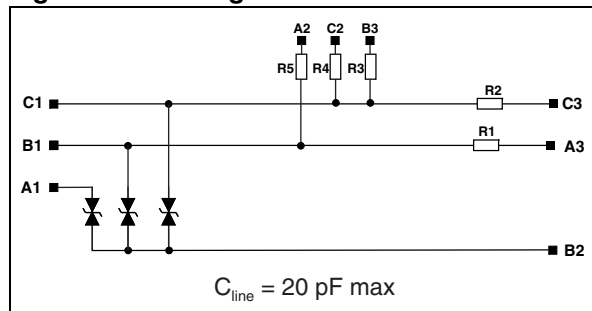


Figure 2. Configuration



TM: IPAD is a trademark of STMicroelectronics.

1 Electrical characteristics

Table 1. Absolute maximum ratings ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

Symbol	Parameter	Value	Unit
V_{PP}	Internal pins (A2, A3, B2, B3, C2, C3):		
	ESD discharge IEC 61000-4-2, level 1, air discharge	± 2	kV
	ESD discharge IEC 61000-4-2, level 1, contact discharge	± 2	
	External pins (A1, B1, C1):		
	ESD discharge IEC 61000-4-2, level 4, air discharge	± 15	
	ESD discharge IEC 61000-4-2, level 4, contact discharge	± 8	
P_d	Line resistance power dissipation at $70\text{ }^{\circ}\text{C}$	60	mW
T_{op}	Operating temperature range	- 40 to + 85	$^{\circ}\text{C}$
T_{stg}	Storage temperature range	- 55 to 150	$^{\circ}\text{C}$

Figure 3. Electrical characteristics (definitions)

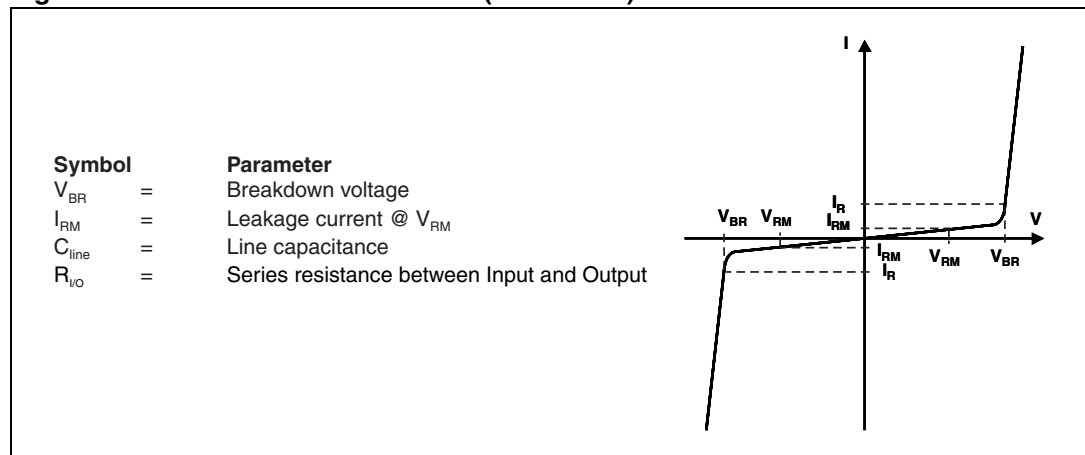


Table 2. Electrical characteristics ($T_{amb} = 25\text{ }^{\circ}\text{C}$)

Symbol	Test conditions	Min.	Typ.	Max.	Unit
V_{BR}	$I_R = 1\text{ mA}$	7			V
I_{RM}	$V_{RM} = 3\text{ V per line}$			100	nA
R_1, R_2	Tolerance $\pm 5\%$		33		Ω
R_4, R_5	Tolerance $\pm 20\%$		18.5		k Ω
R_3		1425	1490	1560	Ω
C_{line}	$V_{line} = 0\text{ V}$, $V_{osc} = 30\text{ mV}$, $F = 1\text{ MHz}$ (measured under zero light conditions)			20	pF

Figure 4. S21 (dB) attenuation measurement on C3-C1 and A3-B1

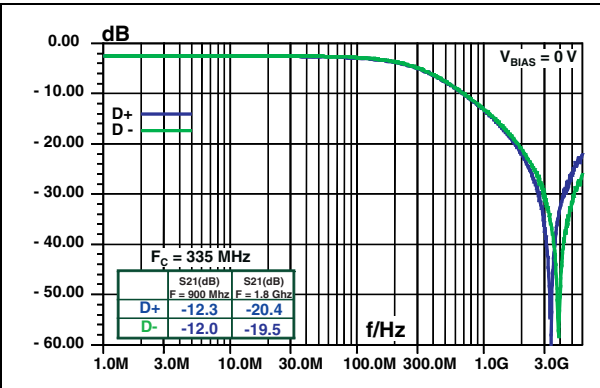


Figure 5. Analog crosstalk measurements on C3 - A1

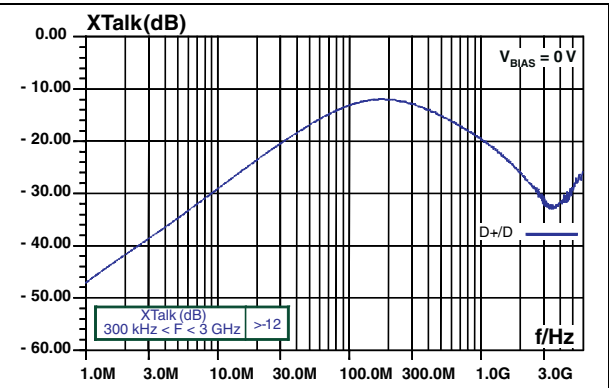


Figure 6. Digital crosstalk measurement on C3-B1 in 50 environment

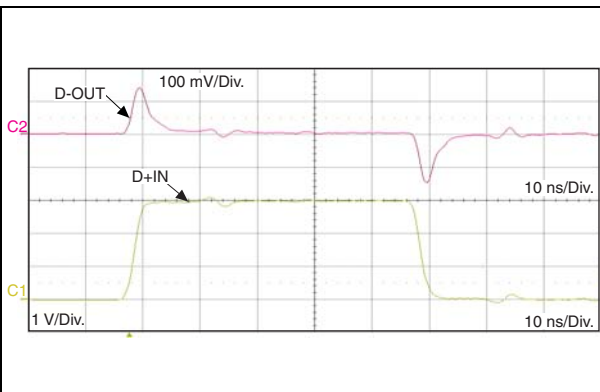


Figure 7. ESD response to IEC 61000-4-2 (+15 kV air discharge) on one input V_(in) and on one output V_(out)

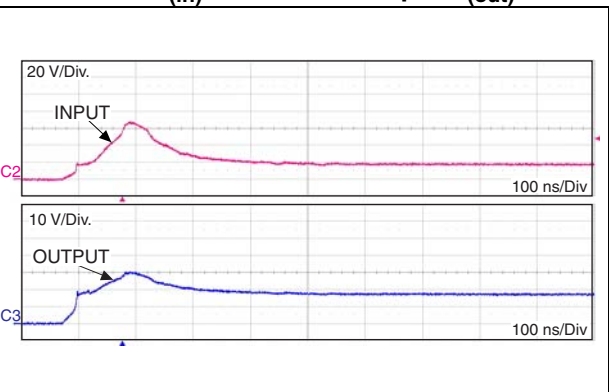


Figure 8. ESD response to IEC 61000-4-2 (-15 kV air discharge) on one input V_(in) and on one output V_(out)

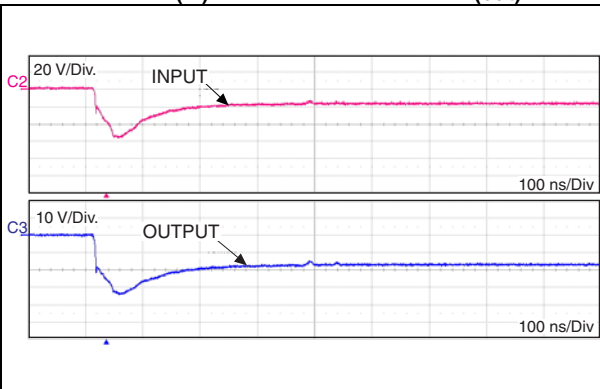
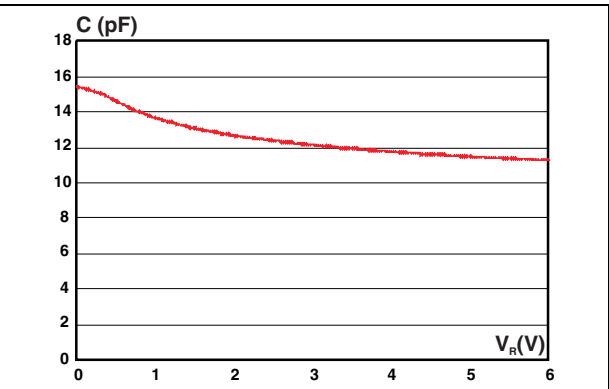
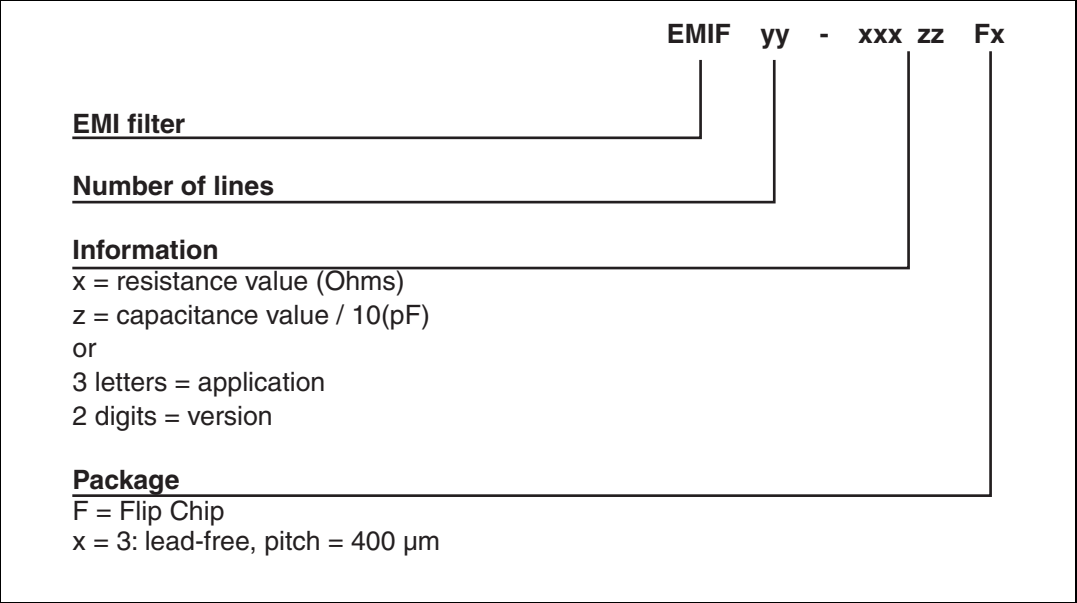


Figure 9. Line capacitance versus applied voltage (typical values, line C1-B2)



2 Ordering information scheme

Figure 10. Ordering information scheme



3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK® is an ST trademark.

Figure 11. Package dimensions

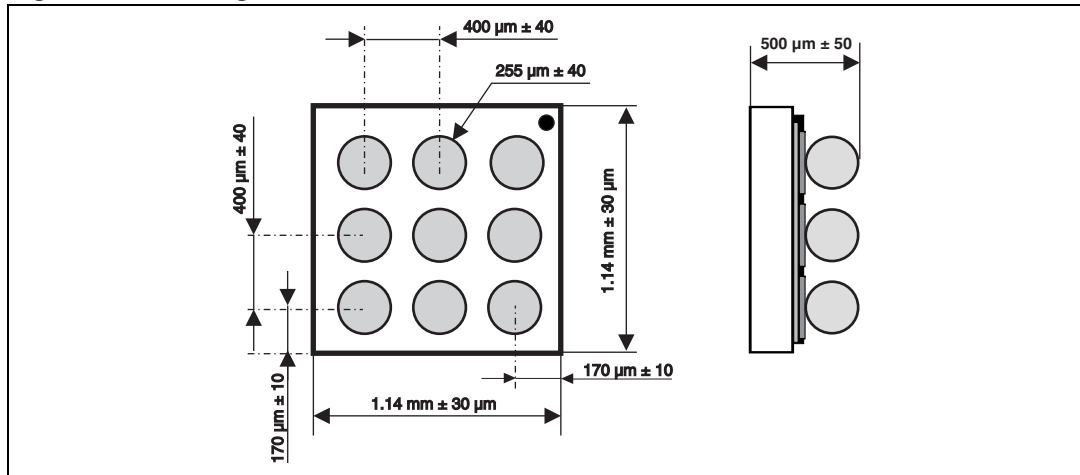


Figure 12. Footprint

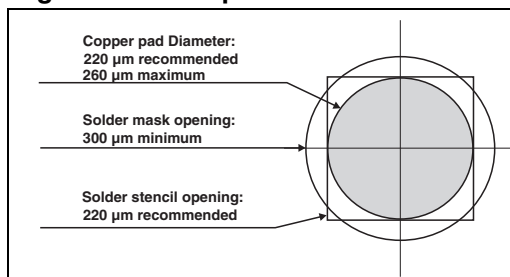


Figure 13. Marking

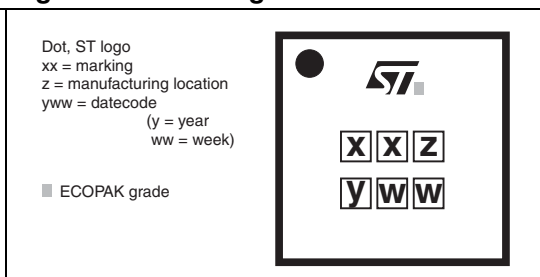
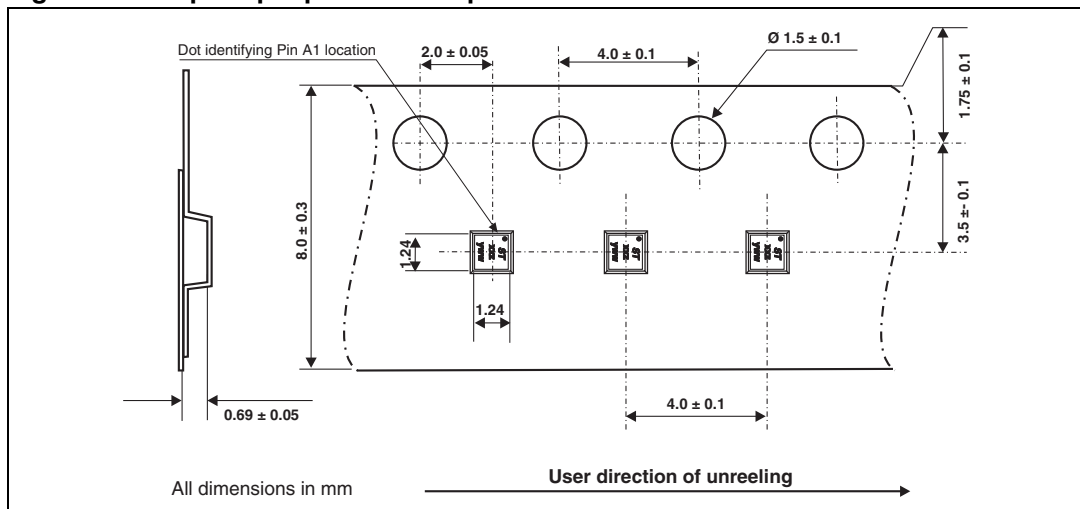


Figure 14. Flip Chip tape and reel specification



4 Ordering information

Table 3. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
EMIF02-USB04F3	JM	Flip Chip	1.4 mg	5000	Tape and reel (7")

Note:

More information is available in the application notes:

AN2348: "STMicroelectronics 400 micro-metre Flip Chip: package description and recommendation for use"

AN1751: "EMI filters: recommendations and measurements"

5 Revision history

Table 4. Document revision history

Date	Revision	Changes
21-Oct-2010	1	First issue.

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